

Pb Free Plating Product

SBL1640CG





16.0 Ampere,45Volt PhotoVoltaic Common Cathode Schottky Barrier Rectifier Diodes

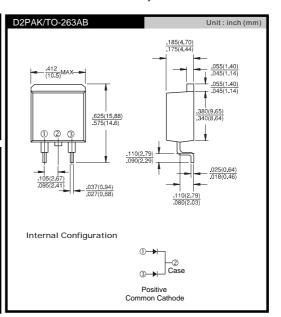
- ★ ThinkiSemi Planar NMBR Technology
- Guardring for overvoltage protection

Features

- Ideally Suited for Automatic Assembly
- Low Forward Voltage
- High Surge Current Capability
- Low Leakage Current
 - * Freewheeling, Snubber, Clamp
 - ★ Solar Junction Box Application

Applications

- PFC
- ★ Plating Power Supply
- ★ Ultrasonic Cleaner and Welder
- ★ Converter & Chopper
- **★** UPS/LED SMPS/HID



Maximum Ratings (T_C = 25°C unless otherwise noted)

Parameter	Symbol	SBL1640CG	Unit
Maximum repetitive peak reverse voltage	VRRM	45V(Typical>50V)	V
Working peak reverse voltage	VRWM	32	V
Maximum DC blocking voltage	VDC	45V(Typical>50V)	V
Maximum average forward rectified current Total device at Tc = 95°C Per leg	lF(AV)	16 8.0	А
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) per leg	IFSM	250	А
Operating junction and storage temperature range	TJ, TSTG	-40 to +125	°C
RMS Isolation voltage (SBLF type only) from terminals to heatsink with t = 1.0 second, RH \leq 30%	Visol	4500 (NOTE 1) 3500 (NOTE 2) 1500 (NOTE 3)	V

Electrical Characteristics (TC = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum instantaneous forward voltage per leg at 10.0 A (Note 4)	VF	0.49V	V
Maximum instantaneous reverse current $T_C = 25^{\circ}C$ at rated DC blocking voltage per leg (Note 4) $T_C = 100^{\circ}C$	I _R	0.5 50	mA

Thermal Characteristics (TC = 25°C unless otherwise noted)

Parameter	Symbol	SBL1640CG	Unit
Typical thermal resistance from junction to case per leg	R⊝JC	1.50	°C/W

- Notes:

 (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset (2) Clip mounting (on case), where leads do overlap heatsink (3) Screw mounting with 4-40 screw, where washer diameter is ≤ 4.9 mm (0.19") (4) Pulse test: 300µs pulse width, 1% duty cycle

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